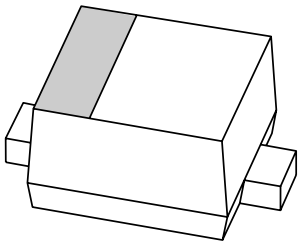
DATA SHEET



BB202
Low-voltage variable capacitance diode

Product specification

2002 Feb 18

Philips
Semiconductors

PHILIPS

Low-voltage variable capacitance diode BB202

FEATURES

- Very steep C/V curve
- C0.2: 30.5 pF; C2.3: 9.5 pF
- C0.2 to C2.3 ratio: min. 2.5
- Very low series resistance
- Ultra small SMD plastic package.

APPLICATIONS

- Electronic tuning in FM radio
- Voltage Controlled Oscillators (VCO).

DESCRIPTION

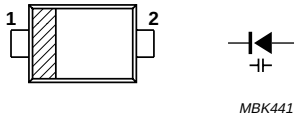
The BB202 is a variable capacitance diode, fabricated in planar technology, and encapsulated in the SOD523 ultra small SMD plastic package.

MARKING

TYPE NUMBER	MARKING CODE
BB202	L2

PINNING

PIN	DESCRIPTION
1	cathode
2	anode



The marking bar indicates the cathode.

Fig.1 Simplified outline (SOD523) and symbol.

LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	MIN.	MAX.	UNIT
V_R	continuous reverse voltage	–	6	V
I_F	continuous forward current	–	10	mA
T_{stg}	storage temperature	–55	+85	°C
T_j	operating junction temperature	–55	+85	°C

ELECTRICAL CHARACTERISTICS

T_j = 25 °C unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
I_R	reverse current	V_R = 6 V; see Fig.3	–	–	10	nA
		V_R = 6 V; T_j = 85 °C; see Fig 3	–	–	100	nA
r_s	diode series resistance	f = 100 MHz; C = 30 pF	–	0.35	0.6	Ω
C_d	diode capacitance	V_R = 0.2; f = 1 MHz; see Fig.2 and Fig.4	28.2	–	33.5	pF
		V_R = 2.3; f = 1 MHz; see Fig.2 and Fig.4	7.2	–	11.2	pF
$\frac{C_{d(0.2V)}}{C_{d(2.3V)}}$	capacitance ratio	f = 1 MHz	2.5	–	–	

GRAPHICAL DATA

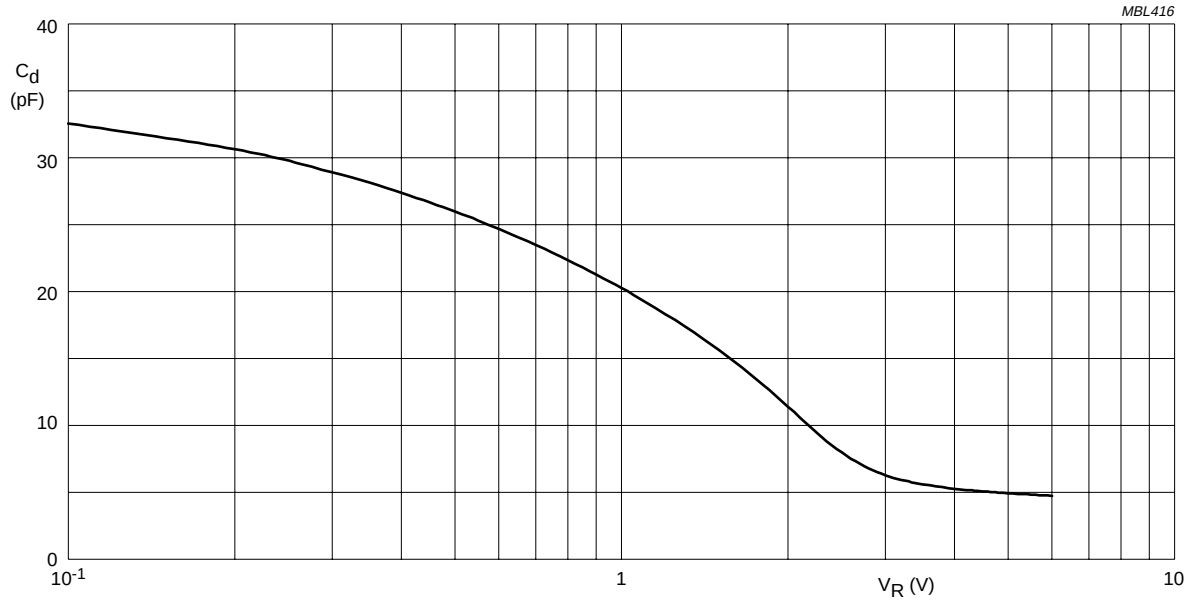


Fig.2 Diode capacitance as a function of reverse voltage; typical values.

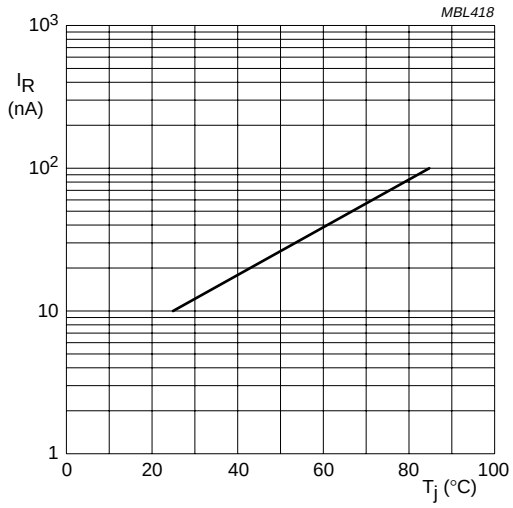


Fig.3 Reverse current as a function of junction temperature; maximum values.

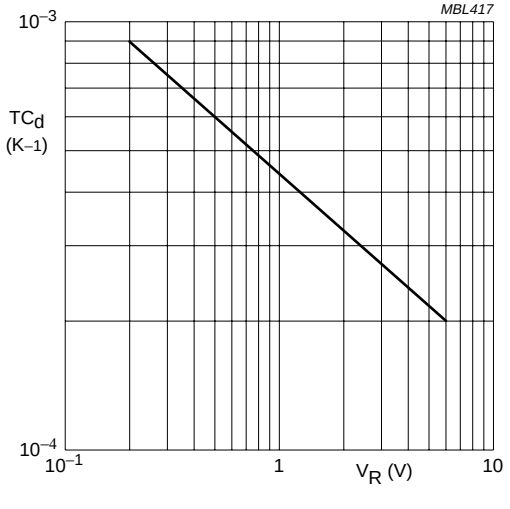
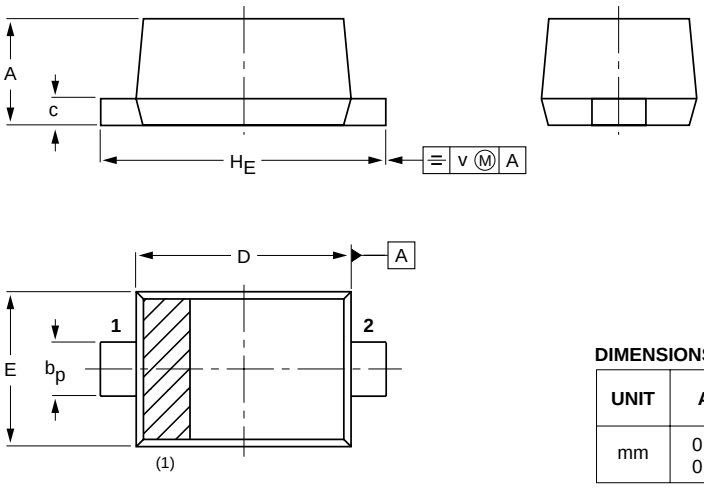
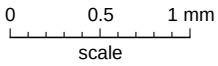


Fig.4 Temperature coefficient of diode capacitance as a function of reverse voltage; typical values.

PACKAGE OUTLINE

Plastic surface mounted package; 2 leads **SOD523**





DIMENSIONS (mm are the original dimensions)

UNIT	A	b_p	c	D	E	H_E	v
mm	0.7 0.5	0.35 0.25	0.2 0.1	1.3 1.1	0.9 0.7	1.7 1.5	0.15

Note

1. The marking bar indicates the cathode.

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOD523			SC-79			98-11-25

DATA SHEET STATUS

DATA SHEET STATUS[1]	PRODUCT STATUS[2]	DEFINITIONS
Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
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Printed in The Netherlands 613514/01/pp8 Date of release: 2002 Feb 18 Document order number: 9397 750 09195

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